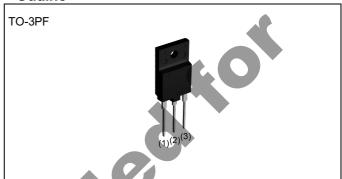


### Nch 650V 15A Power MOSFET

V <sub>DSS</sub>	650V
R <sub>DS(on)</sub> (Max.)	0.315Ω
I <sub>D</sub>	±15A
$P_D$	60W

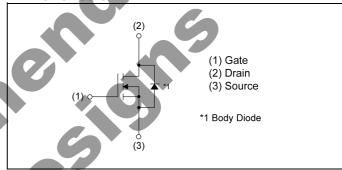
# Outline



### Features

- 1) Low on-resistance
- 2) Ultra fast switching speed
- 3) Parallel use is easy
- 4) Pb-free plating; RoHS compliant

# Inner circuit



# Application

Switching

# Packaging specifications

Packing	Tube
Packing code	C8
Marking	R6515KNZ
Basic ordering unit (pcs)	360

# ● **Absolute maximum ratings** (T<sub>a</sub> = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit	
Drain - Source voltage	$V_{DSS}$	650	V	
Continuous drain current (T <sub>c</sub> = 25°C)	I <sub>D</sub> *1	±15	А	
Pulsed drain current	I <sub>DP</sub> *2	±45	Α	
Cata Sauraa valtara	static	.,	±20	V
Gate - Source voltage	AC(f>1Hz)	$V_{GSS}$	±30	V
Avalanche current, single pulse		I <sub>AS</sub>	2.4	А
Avalanche energy, single pulse		E <sub>AS</sub> *3	310	mJ
Power dissipation (T <sub>c</sub> = 25°C)	P <sub>D</sub>	60	W	
Junction temperature	T <sub>j</sub>	150	°C	
Operating junction and storage temper	rature range	T <sub>stg</sub>	-55 to +150	°C

## ●Thermal resistance

Downwortow	Cymah al	Values			l lait
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R <sub>thJC</sub> *4	-	-	2.1	°C/W
Thermal resistance, junction - ambient	R <sub>thJA</sub>	-	-	40	°C/W
Soldering temperature, wavesoldering for 10s	T <sub>sold</sub>	-		265	°C

# ●Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter Symbol Conditions Min. Typ. Max. Unit	L
Drain - Source breakdown voltage $V_{(BR)DSS}$ $V_{GS} = 0V$ , $I_D = 1mA$ 650 - V	
$V_{DS} = 650V, V_{GS} = 0V$	
Zero gate voltage drain current $I_{DSS}$ $T_j = 25^{\circ}C$ - 100 $\mu$ A	
$T_j = 125^{\circ}C$ - 1000	
Gate - Source leakage current $I_{GSS}$ $V_{GS} = \pm 20V$ , $V_{DS} = 0V$ - $\pm 100$ nA	
Gate threshold voltage $V_{GS(th)}$ $V_{DS} = V_{GS}$ , $I_D = 430\mu A$ 3 - 5 V	
V <sub>GS</sub> = 10V, I <sub>D</sub> = 6.5A	
Static drain - source on - state resistance $R_{DS(on)}^{*5}$ $T_j = 25^{\circ}C$ - 0.280 0.315 $\Omega$	
T <sub>j</sub> = 125°C	
Gate resistance $R_G$ $f$ = 1MHz, open drain - 2.4 - $\Omega$	

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

Darramatar	Cymaela al	Conditions	Values			Linit	
Parameter	Symbol Conditions —		Min.	Тур.	Max.	Unit	
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	1050	-		
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 25V	-	980	-4	pF	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	35			
Turn - on delay time	t <sub>d(on)</sub> *5	$V_{DD} \simeq 300V$ , $V_{GS} = 10V$	-	25			
Rise time	t <sub>r</sub> *5	I <sub>D</sub> = 7.5A	-	35	-		
Turn - off delay time	t <sub>d(off)</sub> *5	$R_L \simeq 40.2\Omega$	-(	.50	-	ns	
Fall time	<b>t</b> <sub>f</sub> *5	$R_G = 10\Omega$	75	20	-		

# ● Gate charge characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Values			Unit
raianielei	Symbol Conditions		Min.	Тур.	Max.	Offic
Total gate charge	$Q_g^{*5}$	V <sub>DD</sub> > 300V	-	27.5	1	
Gate - Source charge	Q <sub>gs</sub> *5	I <sub>D</sub> = 15A	-	7.5	1	nC
Gate - Drain charge	Q <sub>gd</sub> *5	V <sub>GS</sub> = 10V	-	12	-	
Gate plateau voltage	V <sub>(plateau)</sub>	V <sub>DD</sub> ≈ 300V, I <sub>D</sub> = 15A	-	6.6	-	V

<sup>\*1</sup> Limited only by maximum channel temperature allowed.

<sup>\*2</sup> Pw ≤ 10μs, Duty cycle ≤ 1%

<sup>\*3</sup> L $\doteqdot$ 100mH, V<sub>DD</sub>=50V, R<sub>G</sub>=25 $\Omega$ , STARTING T<sub>j</sub>=25°C

<sup>\*4</sup> T<sub>C</sub>=25°C

<sup>\*5</sup> Pulsed

● Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

Parameter	Symbol	Symbol Conditions	Values			Unit
raiainetei	Symbol	Conditions	Min.	Тур.	Max.	Offic
source current	I <sub>S</sub> *1	T 25°C	-	-	15	A
Pulsed source current	I <sub>SP</sub> *2	- T <sub>C</sub> = 25°C	ı	-	45	A
ource-Drain voltage	V <sub>SD</sub> *5	$V_{GS} = 0V, I_{S} = 15A$	-	-	1.5	V
Reverse recovery time	<b>t</b> <sub>rr</sub> *5		-	410	-	ns
Reverse recovery charge	Q <sub>rr</sub> *5	I <sub>S</sub> = 15A di/dt = 100A/μs		5.5	1	μC
eak reverse recovery current	I <sub>m</sub> *5			27	1	А



Fig.1 Power Dissipation Derating Curve

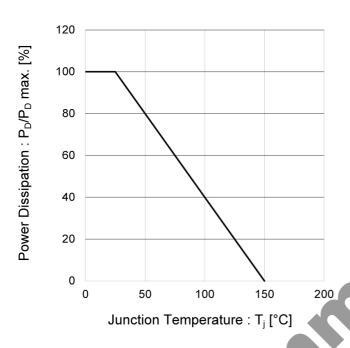


Fig.2 Drain Current Derating Curve

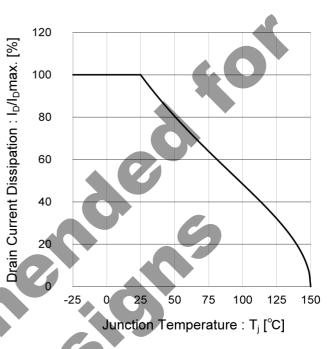


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

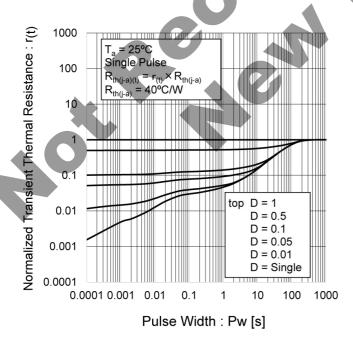


Fig.4 Maximum Safe Operating Area

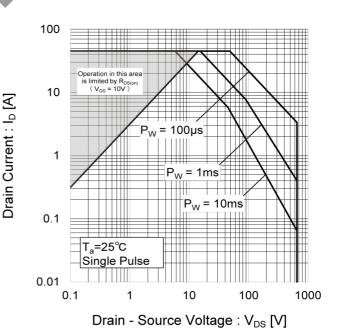


Fig.5 Avalanche Energy Derating
Curve vs. Junction Temperature

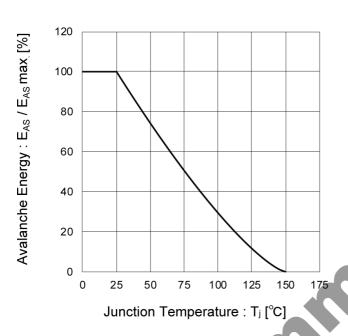


Fig.6 Normalized Breakdown Voltage vs. Junction Temperature

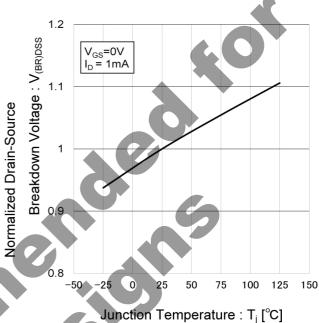


Fig.7 Typical Output Characteristics(I)

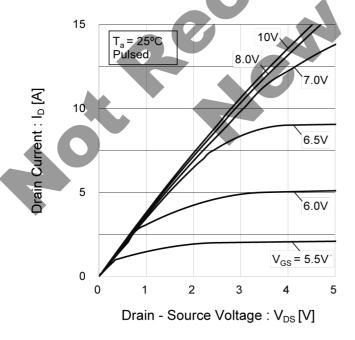
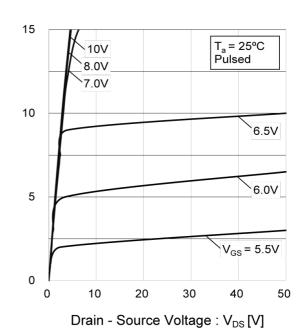


Fig.8 Typical Output Characteristics(II)



Drain Current : I<sub>D</sub> [A]

Fig.9 Typical Transfer Characteristics

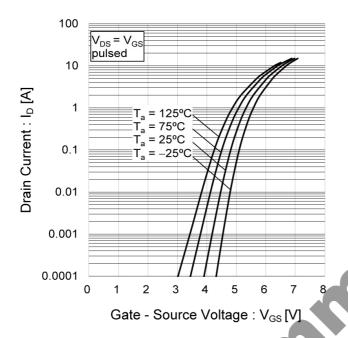


Fig.10 Normalized Gate Threshold .

Voltage vs Junction Temperature

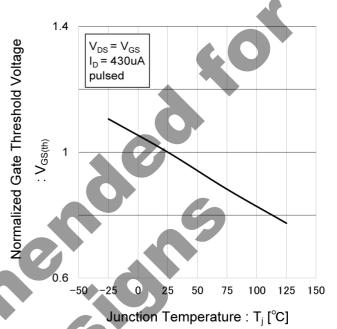


Fig.11 Static Drain - Source On - State
Resistance vs. Drain Current

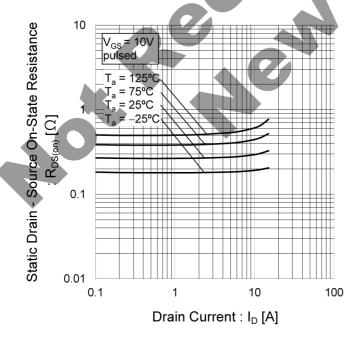


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

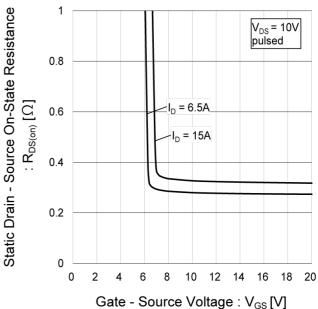


Fig.13 Normalized Static Drain - Source On - State Resistance vs. Junction Temperature

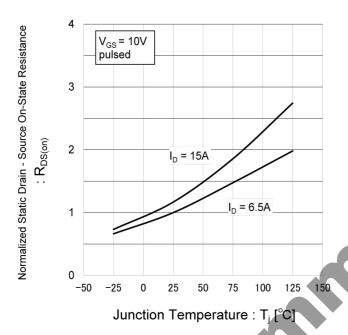


Fig.14 Typical Capacitance vs.

Drain - Source Voltage

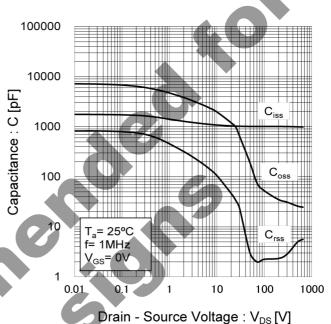


Fig.15 Switching Characteristics

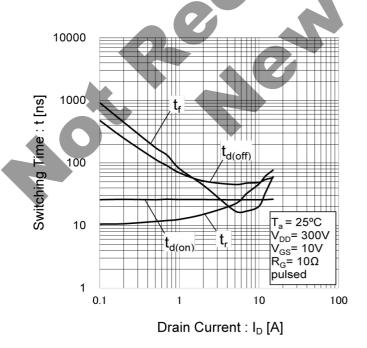
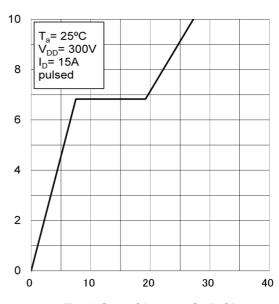


Fig.16 Typical Gate Charge



Gate - Source Voltage : V<sub>GS</sub> [V]

Fig.17 Source Current vs. Source - Drain Voltage

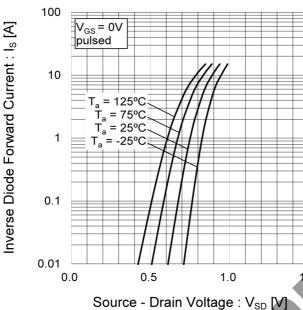
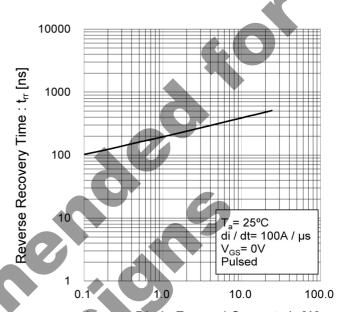


Fig.18 Reverse Recovery Time vs. Inverse Diode Forward Current



Inverse Diode Forward Current: Is [A]



## Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

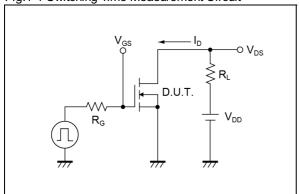


Fig.2-1 Gate Charge Measurement Circuit

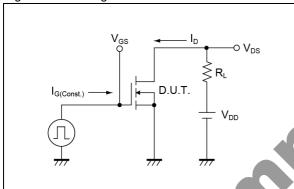


Fig.3-1 Avalanche Measurement Circuit

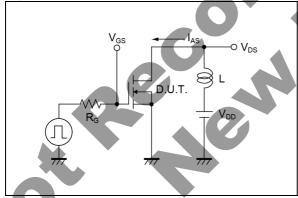


Fig.4-1 trr Measurement Circuit

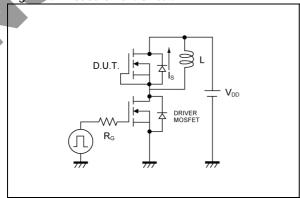


Fig.1-2 Switching Waveforms

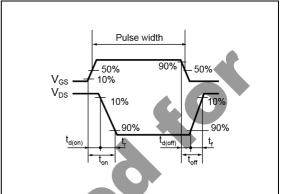


Fig.2-2 Gate Charge Waveform

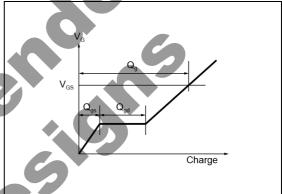


Fig.3-2 Avalanche Waveform

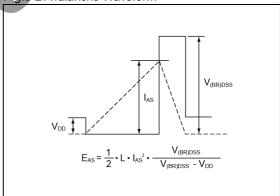
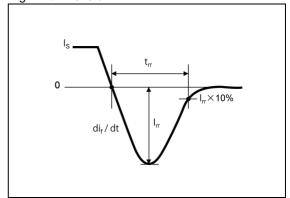
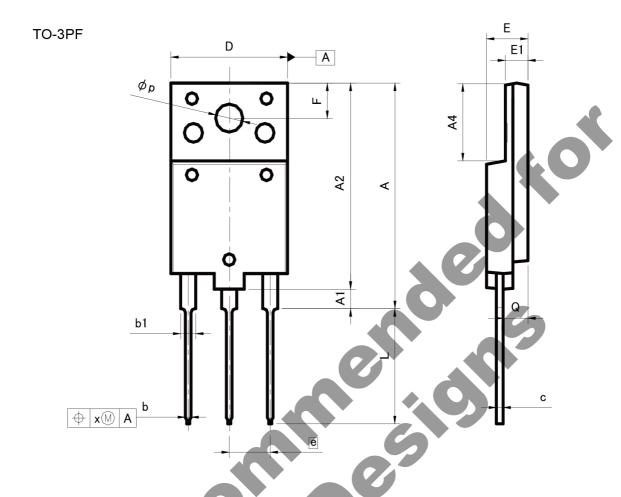


Fig.4-2 trr Waveform



# Dimensions



DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
A	26.30	26.70	1.035	1.051	
A1	2.30	2.70	0.091	0.106	
A2	26.30	26.70	1.035	1.051	
A4	9.80	10.20	0.386	0.402	
b	0.65	0.95	0.026	0.037	
b1	1.80	2.20	0.071	0.087	
С	0.80	1.10	0.031	0.043	
D	15.30	15.70	0.602	0.618	
Е	5.30	5.70	0.209	0.224	
е	5.4	45	0.215	ı	
E1	2.80	3.20	0.110	0.126	
F	4.30	4.70	0.169	0.185	
L	14.60	15.00	0.575	0.591	
р	3.40	3.80	0.134	0.150	
Q	3.10	3.50	0.122	0.138	
Х	_	0.50	_	0.020	

Dimension in mm/inches



Rev.003

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CLASSIV	CLASSⅢ	CLASSⅢ	CLASSII

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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power, exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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